



DMN2005LP4K

N-CHANNEL ENHANCEMENT MODE FIELD EFFECT TRANSISTOR

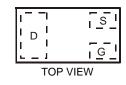
Features

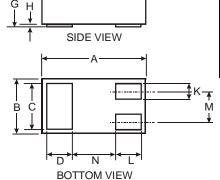
- Low On-Resistance
- Very Low Gate Threshold Voltage, 0.9V Max.
- Fast Switching Speed
- Low Input/Output Leakage
- Ultra-Small Surface Mount Package
- Lead Free By Design/RoHS Compliant (Note 2)
- "Green" Device (Note 4)
- ESD Protected Gate
- Ultra Low Profile Package

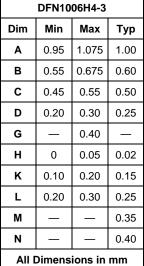
Mechanical Data

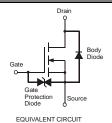
- Case: DFN1006H4-3
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminal Connections: See Diagram
- Terminals: Finish NiPdAu annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Marking: See Page 4
- Ordering & Date Code Information: See Page 4
- Weight: 0.001 grams











Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	20	V
Gate-Source Voltage	V _{GSS}	±10	V
Drain Current per element (Note 1) Continuou Pulsed (N		200 250	mA
Total Power Dissipation (Note 1)	P _d	200	mW
Thermal Resistance, Junction to Ambient	$R_{ heta JA}$	625	°C/W
Operating and Storage Temperature Range	T_j , T_{STG}	-65 to +150	°C

Notes:

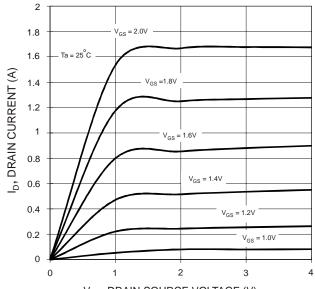
- 1. Device mounted on FR-4 PCB.
- 2. No purposefully added lead.
- 3. Pulse width $\leq 10 \mu S$, Duty Cycle $\leq 1\%$.
- 4. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.



Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (per element) (Note 5)	•					
Drain-Source Breakdown Voltage	BV _{DSS}	20	_	_	V	$V_{GS} = 0V, I_D = 100 \mu A$
Zero Gate Voltage Drain Current	I _{DSS}	_	_	10	μА	$V_{DS} = 17V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_	_	±5	μА	$V_{GS} = \pm 8V$, $V_{DS} = 0V$
ON CHARACTERISTICS (per element) (Note 5)						
Gate Threshold Voltage	$V_{GS(th)}$	0.53	_	0.9	V	$V_{DS} = V_{GS}, I_{D} = 100 \mu A$
Static Drain-Source On-Resistance	R _{DS (ON)}	 	0.9 0.85 1.2 2.4 2.5	1.5 1.7 1.7 3.5 3.5	Ω	$\begin{aligned} &V_{GS} = 4V, \ I_D = 10 \text{mA} \\ &V_{GS} = 2.7V, \ I_D = 200 \text{mA} \\ &V_{GS} = 2.5V, \ I_D = 10 \text{mA} \\ &V_{GS} = 1.8V, \ I_D = 200 \text{mA} \\ &V_{GS} = 1.5V, \ I_D = 1 \text{mA} \end{aligned}$
Forward Transfer Admittance	Y _{fs}	40	_	_	mS	$V_{DS} = 3V, I_{D} = 10mA$

Notes: 5. Short duration test pulse used to minimize self-heating effect.



V_{DS}, DRAIN-SOURCE VOLTAGE (V) Fig. 1 Typical Output Characteristics

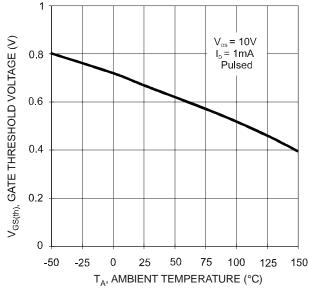


Fig. 3 Gate Threshold Voltage vs. Ambient Temperature

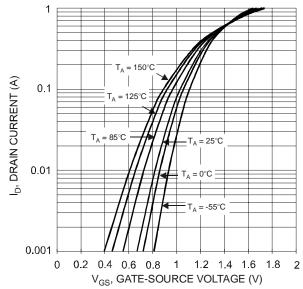


Fig. 2 Reverse Drain Current vs. Source-Drain Voltage

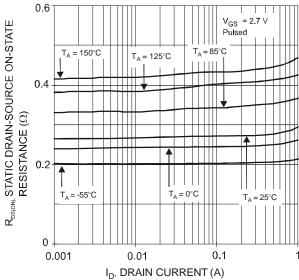


Fig. 4 Static Drain-Source On-State Resistance vs. Drain Current



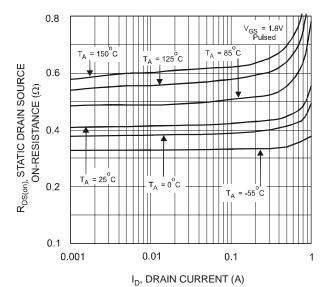


Fig. 5 Static Drain-Source On-Resistance vs. Drain Current

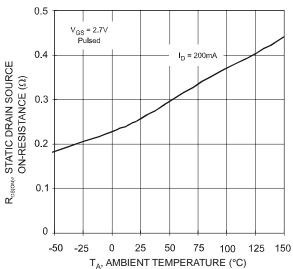


Fig. 7 Static Drain-Source, On-Resistance vs. Ambient Temperature

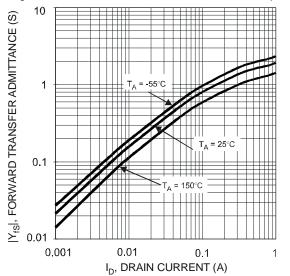
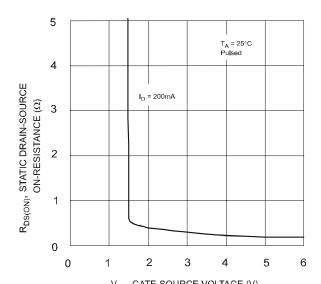
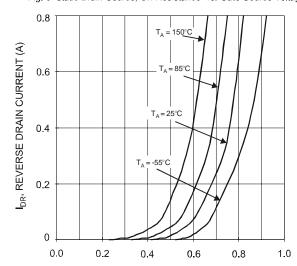


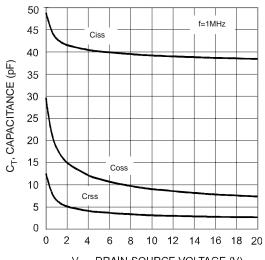
Fig. 9 Forward Transfer Admittance vs. Drain Current



 $\label{eq:VGS} V_{GS}, \, \text{GATE-SOURCE VOLTAGE (V)}$ Fig. 6 Static Drain-Source, On-Resistance vs. Gate-Source Voltage



 $V_{SD,}$ DRAIN-SOURCE VOLTAGE (V) Fig. 8 Reverse Drain Current vs. Source-Drain Voltage



 V_{DS} , DRAIN-SOURCE VOLTAGE (V) Fig. 10 Typical Capacitance



Ordering Information (Note 6)

Device	Packaging	Shipping
DMN2005LP4K-7	DFN1006H4-3	3000/Tape & Reel

Notes: For packaging details, please go to our website at http://www.diodes.com/ap02007.pdf.

Marking Information

• DN

DN = Product Type Marking Code Dot Denotes Drain Side

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